Product Change Notification

Product Group: OPT/Thu Apr 22, 2021/PCN-OPT-1179-2021-REV-0

Redesign of IL300 Linear optocoupler product series

DESCRIPTION OF CHANGE: Vishay introduces a new design for the IL300 series. This design will use a new type of construction and new dies. As a result there is a slight difference in the dimensions of the package. The new package will be white in color and still conforms to the industry standards. There is no change in the manufacturing location. There are some electrical specification changes as well. The major ones are as follows:

K1, K2 gain min and max
IP1, IP2 typ. values
VF typ. value
Reduced K3 bin categories
Rise and Fall time typ. values

For a detailed comparison of the new and current design, please refer to document "Details of changes _ PCN OMV-1179-2021.pdf"

REASON FOR CHANGE: To transfer to a new production line according to state of the art technology with increased production capacity and to change to a more robust new construction.

EXPECTED INFLUENCE ON QUALITY/RELIABILTY/PERFORMANCE: These products have undergone a comprehensive qualification and characterization program. There is no adverse effects on the quality and performance of the product.

PART NUMBERS/SERIES/FAMILIES AFFECTED: Please see materials list on the succeeding page.

VISHAY BRAND(s): Vishay Semiconductors

TIME SCHEDULE:
Start Shipment Date: Thu Jul 22, 2021

SAMPLE AVAILABILITY: April 19, 2021

PRODUCT IDENTIFICATION: This change can be tracked by package colour

QUALIFICATION DATA: This change has been rigorously qualified by company and industry standard qualifications. The qualification data is available upon request

This PCN is considered approved, without further notification, unless we receive specific customer concerns before Wed Jun 30, 2021 or as specified by contract.

ISSUED BY: Nadidedeniz Goerk, Nadidedeniz.Goerk@vishay.com

For further information, please contact your regional Vishay office.

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Product Change Notification

Product Group: OPT/Thu Apr 22, 2021/PCN-OPT-1179-2021-REV-0

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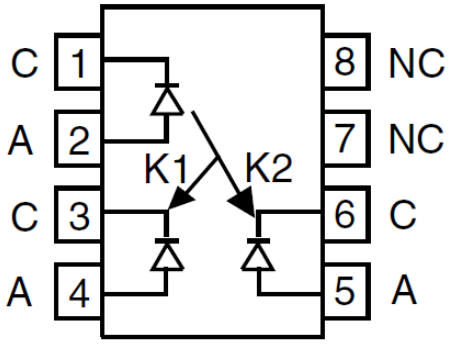
Product Change Notification

Product Group: OPT/Thu Apr 22, 2021/PCN-OPT-1179-2021-REV-0

IL300	IL300-3124	IL300-DEFG	IL300-DEFG-X001	IL300-DEFG-X006
IL300-DEFG-X007	IL300-DEFG-X007T	IL300-DEFG-X009T	IL300-DEFG-X016	IL300-DEFG-X017
IL300-DEFG-X017T	IL300-DEF-X009T	IL300-E	IL300-EF	IL300-EF-X007
IL300-EF-X007T	IL300-EF-X009T	IL300-EF-X016	IL300-EF-X017	IL300-EF-X017T
IL300-E-X006	IL300-E-X007T	IL300-E-X009T	IL300-F	IL300-F-X001
IL300-F-X007	IL300-F-X007T	IL300-F-X009	IL300-F-X009T	IL300-F-X016
IL300-F-X017T	IL300-X007	IL300-X007T	IL300-X009T	IL300-X016
IL300-X017				



Details of Changes to IL300 Series Addressed in PCN OMV-1179-2021

1 1. Contents

PCN OMV-1179-2021

Section **Page**

2 Introduction

This document presents additional information with respect to the changes addressed in PCN OMV-1179-2021 concerning the IL300, linear optocoupler, series products.

2.1 General PCN information

The PCN presents changes to the IL300 series (see detailed list below). This product uses Vishay's new more robust Double Mold Planar Process (DMP). The linear coupler consists of 3 dies, one IrLED and two PIN diodes. The AlGaAs IrLED is optically coupled to both the feedback PIN diode and the output PIN diode in a bifurcated arrangement. These components are encapsulated in a DIP8 plastic package. The final assembly and test occur in Vishay's facility in Krubong, Malaysia.

The changes consist of a redesigning of the product and the transfer of the product to a new production line of cutting edge technology with increased production capacity. The new component also utilizes environmentally friendly material.

The complete list of products impacted by the PCN is listed below:

Material
IL300
IL300-3124
IL300-DEFG
IL300-DEFG-X001
IL300-DEFG-X006
IL300-DEFG-X007
IL300-DEFG-X007T
IL300-DEFG-X009T
IL300-DEFG-X016
IL300-DEFG-X017
IL300-DEFG-X017T
IL300-DEF-X009T

Material
IL300-E
IL300-EF
IL300-EF-X007
IL300-EF-X007T
IL300-EF-X009T
IL300-EF-X016
IL300-EF-X017
IL300-EF-X017T
IL300-E-X006
IL300-E-X007T
IL300-E-X009T
IL300-F

Material
IL300-F-X001
IL300-F-X007
IL300-F-X007T
IL300-F-X009
IL300-F-X009T
IL300-F-X016
IL300-F-X017T
IL300-X007
IL300-X007T
IL300-X009T
IL300-X016
IL300-X017

The new parts were realized by pairing up a new emitter with an improved version of the current detector (PIN diode) to meet the same performance requirements with minimum change to datasheet specifications. The new emitter uses MOVPE manufacturing technology allowing more consistent performance across all products, while the detector is a derivative of the existing product.

Both current and new version of these chips are sourced out of Vishay's fabrication lines in Heilbronn Germany. The DMP construction and process represents a new manufacturing line from our existing factory in Krubong, Malaysia.

3 Changes associated with this PCN.

3.1 Emitter chip change.

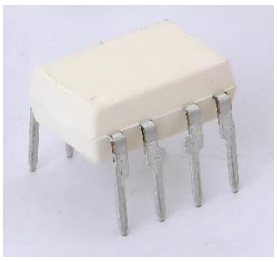
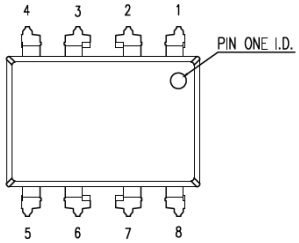
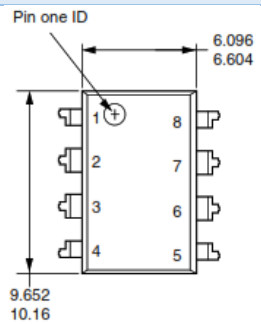
The emitter was revised to the MOVPE multi-quantum well GaAlAs technology to provide a greater light output to achieve product specifications comparable with the current product.

3.2 Detector chip change

The detector is a derivative of the current chip (the difference between the two is not detectable by physical appearance)

3.3 Package

The package has been redesigned resulting in several changes. The most notable of these changes is the colour of the outer molding compound. Less noticeable is the change in construction and the change in package dimensions.

<table>
<tr><th>NEW</th><th>CURRENT</th></tr>
<tr><td colspan="2">Color of Package</td></tr>
<tr><td>  </td><td>  </td></tr>
<tr><td colspan="2">Package Dimension: The package still conforms to the JEDEC standard, some of the dimensions have slight changes.</td></tr>
<tr><td> 
</td><td> 
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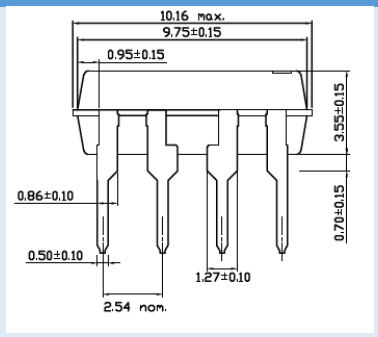
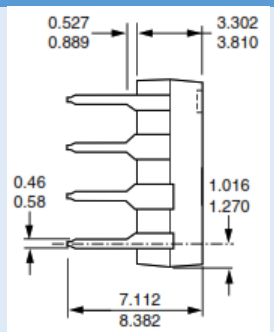
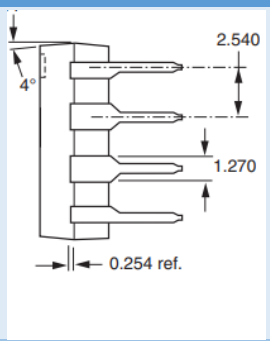
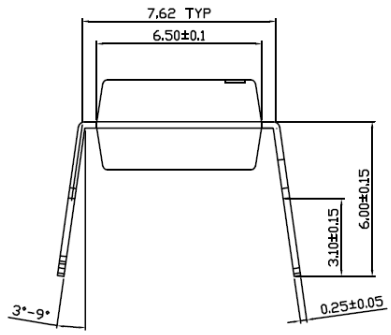
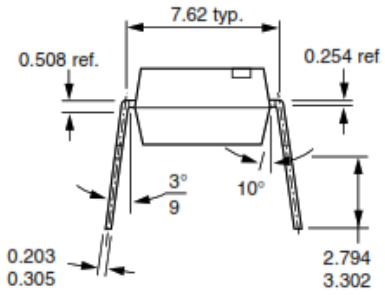
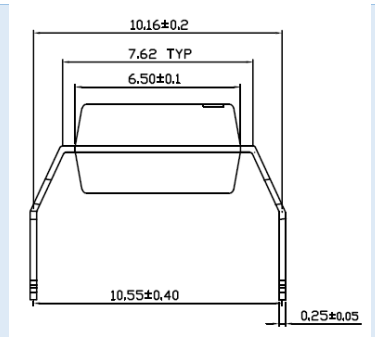
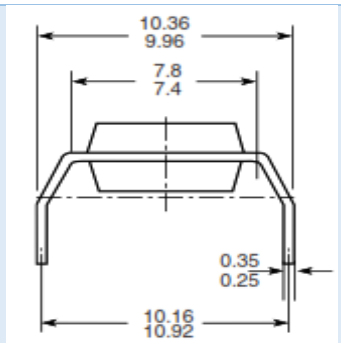
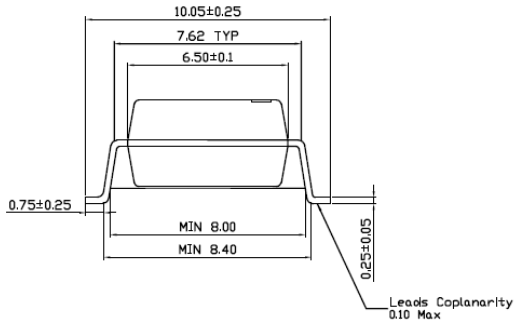
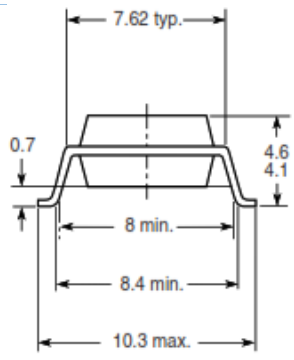
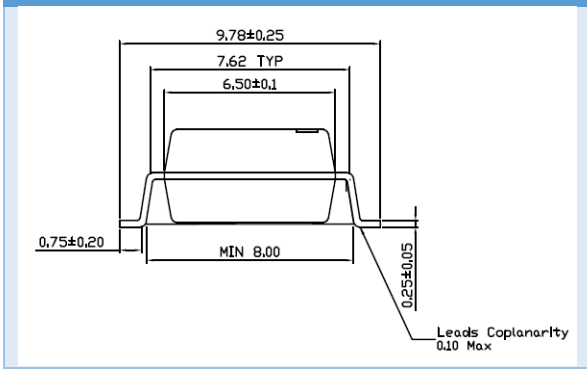
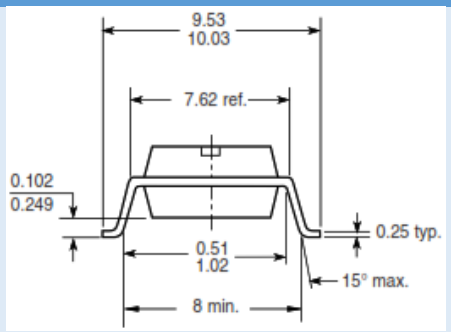
NEW	CURRENT
	 
	
	
	

NEW	CURRENT
	

3.4 Marking

There is no change in product marking

3.5 Production Line

The product has been transferred to a state of the art production line with increased production capacity.

3.6 Miscellaneous

1. Existing Product names will not change.
2. The new parts all retain the same safety agency certification as the current version.
3. There are no changes in the production testing of the product.
4. New Links to resources have been added to the data sheet.

3.7 Specification Changes

Due to the change of the die some of the characteristics will change. These changes are reflected in the typical values in the data sheet as demonstrated in the table below.

	New	Current	units
Forward Voltage (V_F) @ 10mA I_F	1.4	1.25	V
Short circuit Current (I_{SC}) @ 10mA I_F	90	120	µA
Output Current (Ip_1, Ip_2) @ 10mA I_F, V_{det} = -15 V	90	120	µA
K1, K2 Output Current Gain @ 10mA I_F, V_{det} = -15 V	0.009	0.012	
Rise time @ I_F=10mA	0.8	1.75	µs
Fall time @ I_F=10mA	0.8	1.75	µs

The parameter changes are small and fall within the existing data sheet specification.

3.7.1 Changes to Data Sheet limits.

The following shows a comparison of the parametric limits that were changed in the data sheet as a result of this new design.

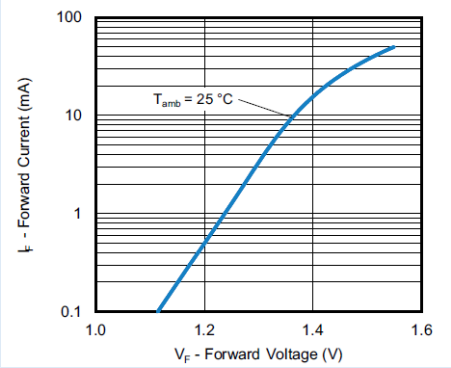
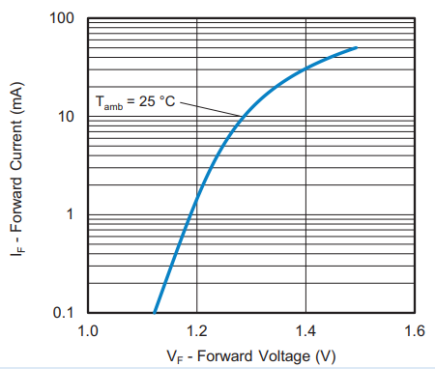
			New				Current			
ABSOLUTE MAXIUM RATINGS										
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**				**VALUE**			**UNIT**
Input Power distribution		Pdiss	100				160			mW
Derate linearly from 25 °C			-				2.13			mW/°C
Input Thermal resistance		R_{th}	-				470			°K/W
Input Junction temperature		T_j	125				100			°C
Output Power: Derate linearly from 25 °C			-				0.65			mW/°C
Input Thermal resistance		R_{th}	-				1500			°K/W
Input Junction temperature		T_j	125				100			°C
Total Package Power distribution at 25°C		Pdiss	150				210			mW
Derate linearly from 25 °C			-				2.8			mW/°C
ELECTRICAL CHARACTERISTICS										
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN**	**TYP.**	**MAX**		**MIN**	**TYP.**	**MAX**	**UNIT**
Forward Voltage	I_F = 10 mA	V_F		1.4				1.25		V
V_F temperature coefficient		$\Delta V_F/\Delta°C$		-				-2.2		mW/°C
Input Junction capacitance	V_F = 0 V, f = 1 MHz	C_j		26				15		pF
Input Dynamic resistance	I_F = 10 mA	$\Delta V_F/\Delta I_F$		-				6		Ω
Output short circuit current	I_F = 10 mA	I_{SC}		90				120		µA
Output noise equivalent power	V_{det} = 15V	NEP		-				4×10^{-14}		Ω/√Hz
K1, servo gain (I_{P1}/I_F)	I_F = 10 mA, V_{det} = -15 V	K1	0.005	0.009	0.015		0.006	0.012	0.017	
Servo photocurrent	I_F = 10 mA, V_{det} = -15 V	I_{P1}		90				120		µA
K2, servo gain (IP2/IF)	I_F = 10 mA, V_{det} = -15 V	K2	0.005	0.009	0.015		0.006	0.012	0.017	
Forward photocurrent	I_F = 10 mA, V_{det} = -15 V	I_{P2}		90				120		µA

3.7.2 Corrections to the current datasheet

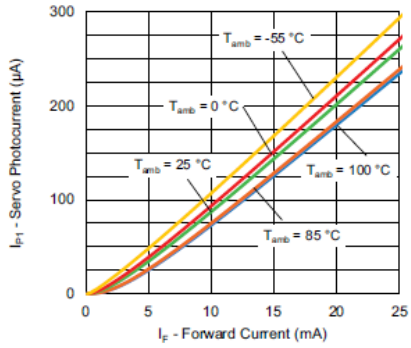
The test condition for Transfer Gain Stability has been corrected with T_{amb} = 0 °C to 75 °C.
The test condition for Transfer Gain Linearity has been corrected with I_F = 2.0 to 10 mA

3.8 Characteristics

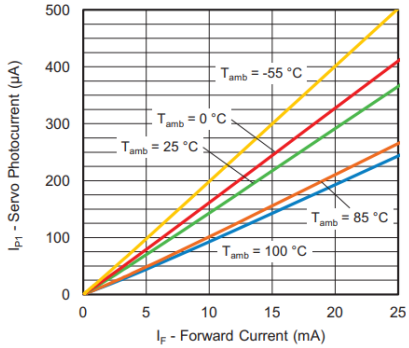
Detailed product characterization has been performed on this series of products. Some slight changes in electrical parameters and performance were observed.

New	Current
Forward Current vs. Forward voltage	Forward Current vs. Forward voltage
	

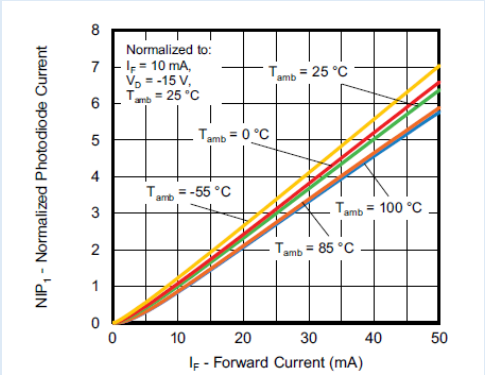
Servo Photocurrent vs. Forward Current



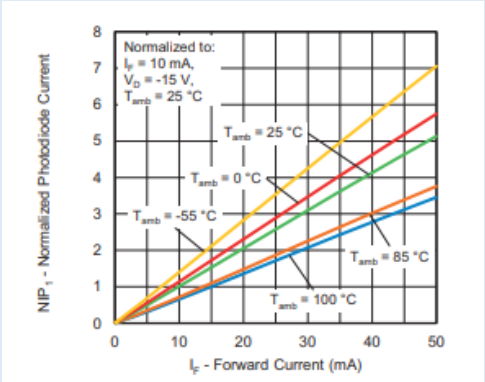
Servo Photocurrent vs. Forward Current



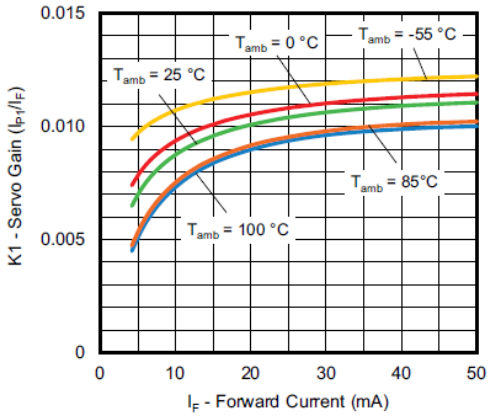
Normalized Photodiode Current vs. Forward Current



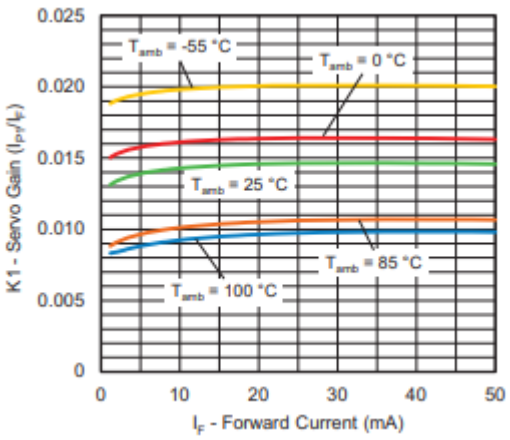
Normalized Photodiode Current vs. Forward Current



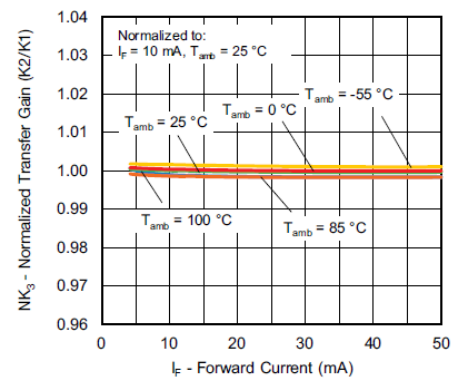
Servo Gain vs. Forward Current



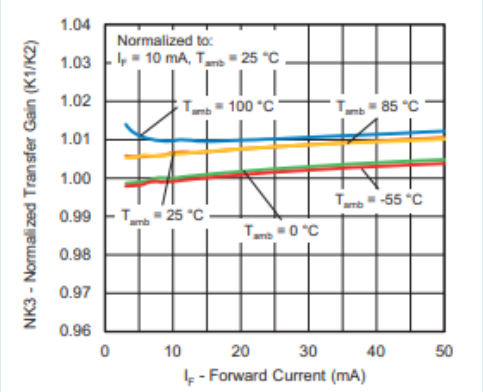
Servo Gain vs. Forward Current



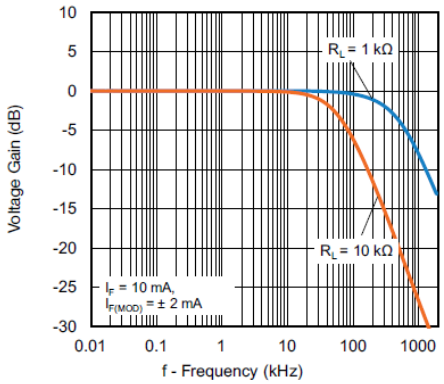
Normalized Transfer Gain vs. Forward Current



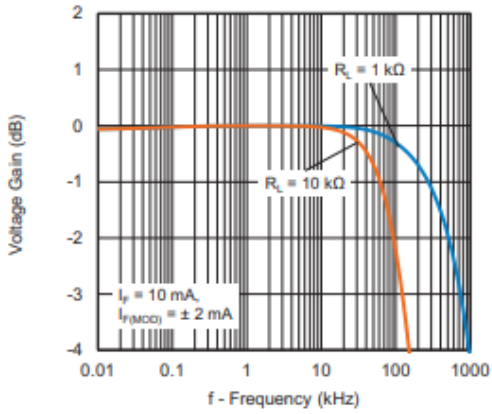
Normalized Transfer Gain vs. Forward Current



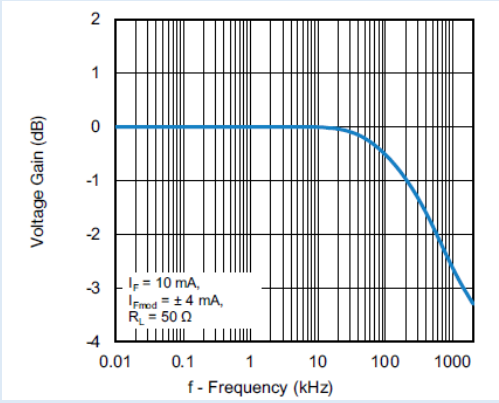
Voltage Gain vs. Frequency (2 mA)



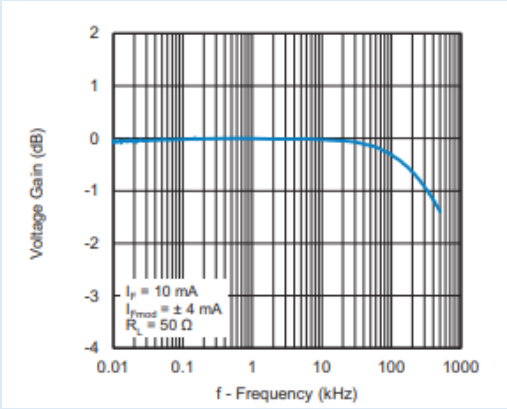
Voltage Gain vs. Frequency (2 mA)



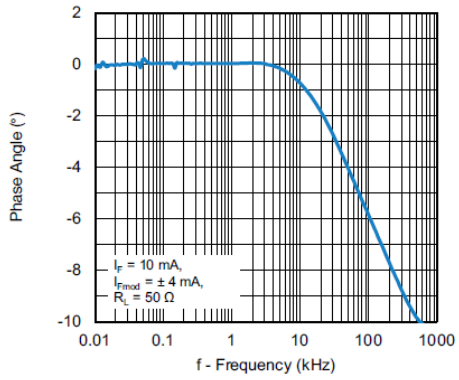
Voltage Gain vs. Frequency



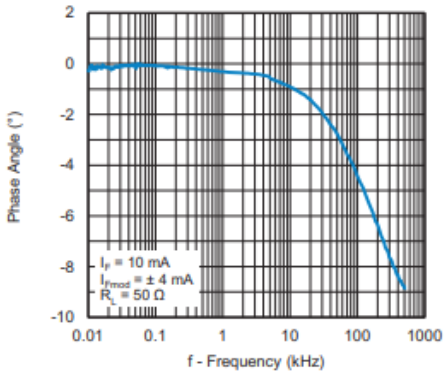
Voltage Gain vs. Frequency



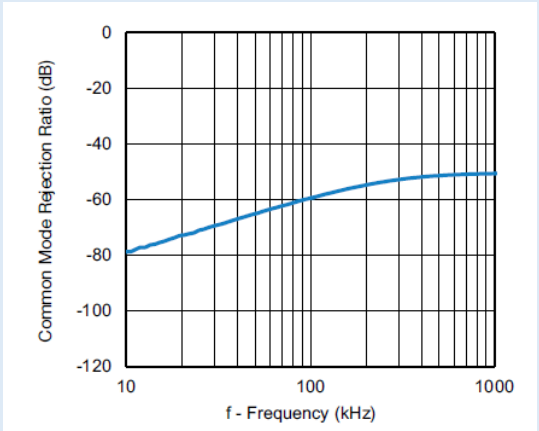
Phase Angle vs. Frequency



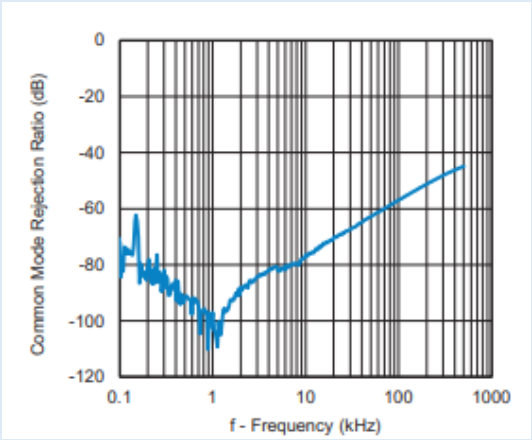
Phase Angle vs. Frequency



Common-Mode Rejection Ratio vs. Frequency



Common-Mode Rejection Ratio vs. Frequency



Vishay Material Code	Customer Material	Location	Total Quantity	Backlog Quantity
IL300	IL300	CHANDLER	6000.00	0.00
IL300-DEFG	IL300-DEFG	CHANDLER	18000.00	0.00
IL300-DEFG-X017	IL300-DEFG-X017	CHANDLER	2000.00	0.00
IL300-DEFG-X017T	IL300-DEFG-X017T	CHANDLER	7000.00	0.00
IL300-E	IL300-E	CHANDLER	10000.00	6000.00
IL300-EF	IL300-EF	CHANDLER	28000.00	12000.00
IL300-EF-X009T	000000000009462791	CHANDLER	1000.00	0.00
IL300-EF-X009T	IL300-EF-X009T	CHANDLER	5000.00	0.00
IL300-F	IL300-F	CHANDLER	22000.00	8000.00
IL300-F-X007	IL300-F-X007	CHANDLER	12000.00	4000.00
IL300-F-X009	IL300-F-X009	CHANDLER	4000.00	0.00
IL300-F-X009T	000000000009462804	CHANDLER	11000.00	0.00
IL300-F-X009T	IL300-F-X009T	CHANDLER	76000.00	30000.00
IL300-F-X016	IL300-F-X016	CHANDLER	0.00	0.00